

# 1A Low Dropout Positive Regulator

#### DESCRIPTION

The AMC1117 series of positive adjustable and fixed regulators is designed to provide 1A for applications requiring high efficiency. All internal circuitry is designed to operated down to 800mV input to output differential and the dropout voltage is fully specified as a function of load current.

The AMC1117 offers current limiting and thermal protection. The on chip trimming adjusts the reference voltage accuracy to 1%.

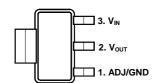
#### **FEATURES**

- Output current of 1A typical
- Three-terminal adjustable or fixed 1.5V, 1.8V, 2.5V, 3.3V, 5.0V outputs
- Low dropout of typical 800mV
- **■** Thermal protection built in
- **■** Typical 0.015% line regulation
- Typical 0.01% load regulation
- **■** Fast transient response
- Available in SOT-223 and TO-252 packages
- Pin assignment identical to earlier LT1117 series.

#### **APPLICATIONS**

- 2.85V Model for SCSI-2 Active Termination
- Battery Charger
- High Efficiency Linear Regulators
- Battery Powered Instrumentation
- Post Regulator for Switching DC/DC Converter

#### PACKAGE PIN OUT



3-Pin Plastic SOT-223 Surface Mount (Top View)

# 3. V<sub>IN</sub> 2. V <sub>out</sub> 1. ADJ/GND

3-Pin Plastic TO-252 Surface Mount (Top View)

#### **VOLTAGE OPTIONS**

AMC1117-1.5	- 1.5V Fixed
AMC1117-1.8	- 1.8V Fixed
AMC1117-2.5	-2.5V Fixed
AMC1117-3.3	-3.3V Fixed
AMC1117-5.0	-5.0V Fixed

AMC1117 – Adjustable Output

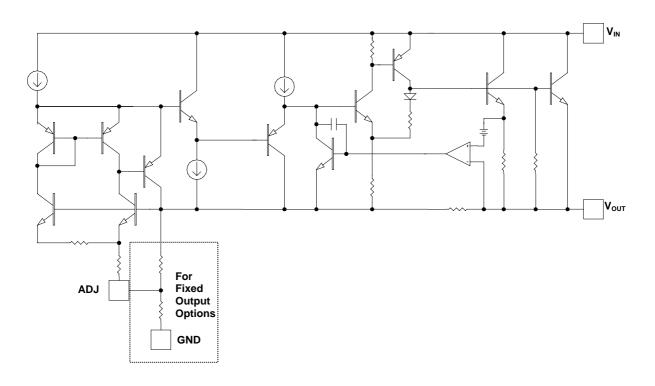
ORDER INFORMATION					
T. (90)	SK SOT-223	SJ TO-252			
$T_A$ ( ${}^{\circ}C$ )	3-pin	3-pin			
0.40.70	AMC1117-X.XSKF (Lead Free)	AMC1117-X.XSJF (Lead Free)			
0 to 70	AMC1117SJF (Lead Free)				
Note: 1.All surface-mount packages are available in Tape & Reel. Append the letter "T" to part number (i.e. AMC1117-X.XSJT)					

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2.The letter "F" is marked for Lead Free process.



# **BLOCK DIAGRAM**





ABSOLUTE MAXIMUM RATINGS (Note1)	
Input Voltage	7V
Operating Junction Temperature Range, T <sub>J</sub>	0°C to 150°C
Storage Temperature Range	-65 °C to 150 °C
Lead Temperature (soldiering, 10 seconds)	260°C
Note 1: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. out of the specified terminal.	Currents are positive into, negative

	POWER DISSIPATION TABLE								
Ī	Package $\theta_{JA}$ Derating factor ( mW/°C) $T_A \le 25$ °C $T_A = 70$ °C $T_A = 85$ °C								
		$(^{\circ}C/W)$	$T_A \ge 25  ^{\circ}C$	Power rating(mW)	Power rating(mW)	Power rating (mW)			
	SKF	136	7.35	919	588	478			
	SJF	80	12.5	1562	1000	812			

#### Note:

- 1.  $\theta_{JA}$ : Thermal Resistance-Junction to Ambient,  $D_F$ : Derating factor, Po: Power consumption. Junction Temperature Calculation:  $T_J = T_A + (P_D \times \theta_{JA})$ ,  $P_D = D_F \times (T_J T_A)$  The  $\theta_{JA}$  numbers are guidelines for the thermal performance of the device/PC-board system. All of the above assume no ambient airflow.
- 2.  $\theta_{JT}$ : Thermal Resistance-Junction to Tab,  $T_C$ : case(Tab) temperature,  $T_J = T_C + (P_D \times \theta_{JT})$  For SK package,  $\theta_{JT} = 15.0\,^{\circ}$ C /W. For SJ package,  $\theta_{JT} = 7.0\,^{\circ}$ C /W.

#### RECOMMENDED OPERATING CONDITIONS **Recommended Operating Conditions** Parameter Symbol Units Min. Typ. Max. V Input Voltage $V_{IN}$ 2.7 7 Load Current (with adequate heat sinking) 5 $I_{\rm o}$ mAInput Capacitor (V<sub>IN</sub> to GND) 10 μF Output Capacitor with ESR of $10\Omega$ max., ( $V_{OUT}$ to GND) 10 μF $^{\rm o}$ C Junction temperature $T_{\rm J}$ 125



	ELECTRICAL CHARACTERISTICS								
Unless otherwise specified, $I_O = 10$ mA, and $T_J = 25$ °C.									
Parameter		Symbol	Test Conditions	A	AMC1117				
		Symbol	Test Conditions	Min	Тур	Max	Units		
Reference	AMC1117	$V_{ m REF}$	$I_{\rm O}=10{\rm mA,V_{\rm IN}}=5{\rm V}$	1.238	1.250	1.262	V		
Voltage	7 AIVICITI	▼ REF	$10mA \le I_O \le 1A, \ 2.65V \le V_{IN} \le 7V$	1.225	1.250	1.275	<u> </u>		
	AMC1117-1.5		$I_0 = 10 \text{mA}, V_{IN} = 3.0 \text{V}$	1.485	1.500	1.515			
	AWICTIT/-1.3		$10\text{mA} \le I_{O} \le 1\text{A}, \ 3.0\text{V} \le V_{IN} \le 7\text{V}$	1.470	1.500	1.530			
	AMC1117-1.8		$I_O = 10 \text{mA}, V_{IN} = 3.3 \text{V}$	1.782	1.8	1.818			
	AWICTIT/-1.8		$10\text{mA} \le I_{\text{O}} \le 1\text{A}, 3.3\text{V} \le V_{\text{IN}} \le 7\text{V}$	1.764	1.8	1.836			
Output	AMC1117-2.5	17	$I_{\rm O} = 10 {\rm mA}, V_{\rm IN} = 4.0 {\rm V}$	2.475	2.500	2.525	V		
Voltage	AMC1117-2.3	$V_{OUT}$	$10\text{mA} \le I_{O} \le 1\text{A}, 4.0\text{V} \le V_{IN} \le 7\text{V}$	2.450	2.500	2.550			
	AMC1117 2 2		$I_{\rm O} = 10 {\rm mA}, V_{\rm IN} = 4.8 {\rm V}$	3.267	3.300	3.333			
	AMC1117-3.3		$10\text{mA} \le I_{O} \le 1\text{A}, 4.8\text{V} \le V_{IN} \le 7\text{V}$	3.235	3.300	3.365			
	AMC1117-5.0		$I_O = 10 \text{mA}, V_{IN} = 6.5 \text{V}$	4.950	5.000	5.050			
			$10\text{mA} \le I_{\text{O}} \le 1\text{A}, 6.5\text{V} \le V_{\text{IN}} \le 7\text{V}$	4.900	5.000	5.100			
Line	AMC1117	A 3.7	$I_{O} = 10 \text{mA}, V_{OUT} + 1.5 \text{V} \le V_{IN} \le 7 \text{V}$		0.04	0.20	%		
Regulation	AMC1117-X.X	$\Delta V_{OI}$	$I_{O} = 10 \text{mA}, V_{OUT} + 1.5 \text{V} \le V_{IN} \le 7 \text{V}$		1.0	6.0	mV		
Load	AMC1117	$\Delta V_{OL}$	$10 \text{mA} \le I_{\text{O}} \le 1 \text{A}, V_{\text{IN}} = V_{\text{OUT}} + 1.5 \text{V}$		0.10	0.40	%		
Regulation	AMC1117-X.X		$10 \text{mA} \le I_{\text{O}} \le 1 \text{A}, V_{\text{IN}} = V_{\text{OUT}} + 1.5 \text{V}$		1.0	10.0	mV		
			$I_{O} = 10 \text{mA}, V_{IN} \ge 2.65 \text{V}$		0.8	1.15			
Dropout Vo	ltage	ΔV	$I_{\rm O} = 500 {\rm mA}, V_{\rm IN} \ge 2.65 {\rm V}$		0.8	1.25	V		
			$I_{\rm O} = 1$ A, $V_{\rm IN} \ge 2.65$ V		0.8	1.30			
Minimum Load Current (Note 1)			$V_{\rm IN} \leq 7V$		2	7	mA		
Quiescent Current AMC1117-X.X		$I_Q$	$V_{IN} \le 7V$		6	13	mA		
Current Limit		$I_{CL}$	$V_{IN} - V_{OUT} = 3V$	1	1.2		A		
Adjust Pin	Current		$I_O = 10$ mA, $V_{IN} - V_{OUT} = 2V$		50	120	μΑ		
Thermal Re	egulation (Note 2)		$T_A = 25$ °C, 30 ms pulse		0.01	0.1	%/W		
Ripple rejection (Note 2)		$R_R$	$f_O = 120$ Hz, $1V_{RMS}$ , $I_O = 400$ mA, $V_{IN} - V_{OUT} = 3V$	60	75		dB		

For the adjustable device, the minimum load current is the minimum current required to maintain regulation. Normally the current in Note 1: the resistor divider used to set the output voltage is selected to meet the minimum load current requirement.

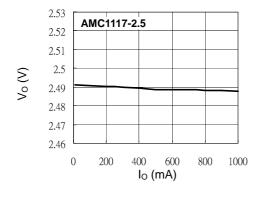
These parameters, although guaranteed, are not tested in production. Note 2:



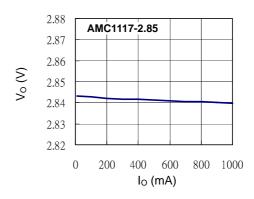
#### **CHARACTERIZATION CURVES**

Unless otherwise specified,  $V_{IN}\!\!=V_{OUT}\!\!+\!\!2V$  ,  $C_{IN}\!\!=\!\!1\mu F$  ,  $C_{OUT}\!\!=\!\!4.7\mu F$  ,  $T_A\!\!=\!\!25^{\rm o}C$ 

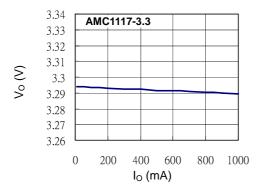
# **Load Regulation**



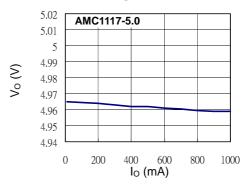
#### **Load Regulation**



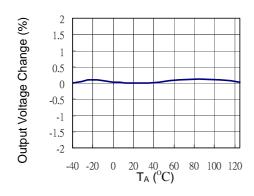
# **Load Regulation**



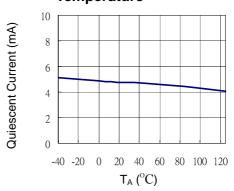
#### **Load Regulation**



# **Temperature Stability**

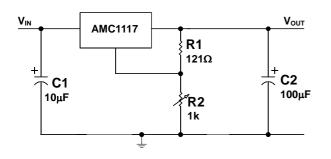


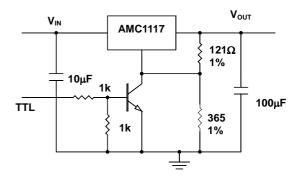
# Quiescent Current vs. Temperature





#### APPLICATION INFORMATION

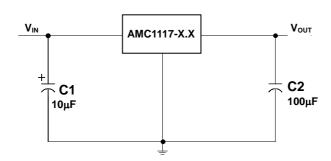




# **Adjustable Regulator**

 $V_{OUT} = 1.25V (1 + \frac{R2}{R1})$ 

# 5V Regulator with Shutdown



**Fixed Voltage Regulator** 



# **Application Note:**

#### **Maximum Power Calculation:**

T<sub>I</sub>(°C): Maximum recommended junction temperature

T<sub>A</sub>(°C): Ambient temperature of the application

 $\theta_{JA}(^{\circ}C/W)$ : Junction-to-junction temperature thermal resistance of the package, and other heat dissipating materials.

#### The maximum power dissipation of a single-output regulator :

$$P_{\text{D(MAX)}} \! = \! \left[ \left( V_{\text{IN(MAX)}} \text{ - } V_{\text{OUT(NOM)}} \right) \right] \times I_{\text{OUT(NOM)}} + V_{\text{IN(MAX)}} \! \times I_{\text{Q}}$$

Where:  $V_{OUT(NOM)}$  = the nominal output voltage

 $I_{OUT(NOM)}$  = the nominal output current, and

 $I_O$  = the quiescent current the regulator consumes at  $I_{OUT(MAX)}$ 

 $V_{IN(MAX)}$  = the maximum input voltage

Then  $\theta_{IA} = (150 \, {}^{\circ}\text{C} - \text{T}_{A}) / P_{D}$ 

#### Thermal consideration:

When power consumption is over about 404 mW (for SOT-223 package, 687mW for TO-252 package, at  $T_A$ =70 °C), additional heat sink is required to control the junction temperature below 125 °C.

The junction temperature is:  $T_J = P_D (\theta_{JT} + \theta_{CS} + \theta_{SA}) + T_A$ 

P<sub>D</sub>: Dissipated power.

 $\theta_{JT}$ : Thermal resistance from the junction to the mounting tab of the package.

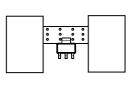
 $\theta_{CS}$ : Thermal resistance through the interface between the IC and the surface on which it is mounted. (Typically,  $\theta_{CS} \le 1.0^{\circ} \text{C/W}$ )

 $\theta_{SA}$ : Thermal resistance from the mounting surface to ambient (thermal resistance of the heat sink).

If PC Board copper is going to be used as a heat sink, below table can be used to determine the appropriate size of copper foil required. For multi-layered PCB, these layers can also be used as a heat sink. They can be connected with several through hole vias.

PCB $\theta_{SA}(^{\circ}C/W)$	59	45	38	33	27	24	21
PCB heat sink size (mm <sup>2</sup> )	500	1000	1500	2000	3000	4000	5000

Recommended figure of PCB area used as a heat sink.





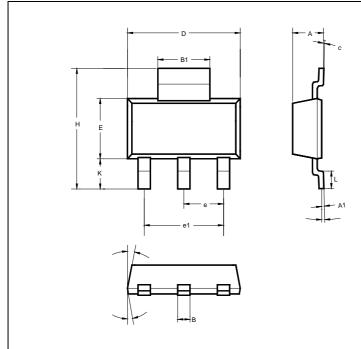


(Bottom View)



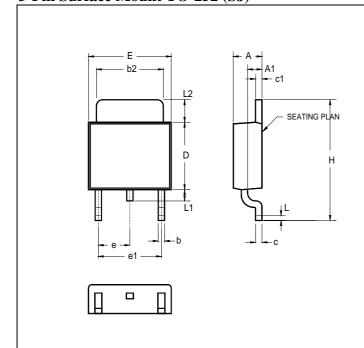
#### **PACKAGE**

# 3-Pin Surface Mount SOT-223 (SK)



	MILLIMETERS					
	MIN TYP MAX					
Α	1.50	1.65	1.80			
A1	0.02	0.05 0.08				
В	0.60	0.70	0.80			
B1	2.90	-	3.15			
С	0.28	0.30	0.32			
D	6.30	6.50	6.70			
E	3.30	3.50	3.70			
е		2.3 BSC				
e1		4.6 BSC				
Н	6.70	7.00	7.30			
L	0.91	1.00	1.10			
K	1.50	1.75	2.00			
α	0°	5°	10°			
β		3°				

# 3-Pin Surface Mount TO-252 (SJ)



		NCHES	3	MILLIMETERS			
	MIN	TYP	MAX	MIN	TYP	MAX	
Α	0.086	-	0.094	2.18	-	2.39	
A1	0.040	-	0.050	1.02	-	1.27	
b	-	0.024	-	-	0.61	-	
b2	0.205	1	0.215	5.21	ı	5.46	
С	0.018	-	0.023	0.46	-	0.58	
c1	0.018	-	0.023	0.46	-	0.58	
D	0.210	ı	0.220	5.33	ı	5.59	
Е	0.250	-	0.265	6.35	-	6.73	
е	0.	.090 BS	С	2	.29 BS	29 BSC	
e1	0.180 BSC			4.58 BSC			
Н	0.370	-	0.410	9.40	-	10.41	
L	0.020	-	-	0.51	-		
L1	0.025	-	0.040	0.64	-	1.02	
L2	0.060	-	0.080	1.52	-	2.03	



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